IPC ASSOCIATION CONNECTELECTRONICS INDUSTRI	Material Compo © Copyright 2005. IF international and Pan	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfg Information			
upplier Infor	mation														
Company name*			Company unique ID			J	Unique ID Authority					Response Date*			
nsemi											2024-05	2024-05-18			
Contact Name		Title - Contact			I	Phone - Contact*				Email - Contact*					
Product-Env-Ste	wards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Repre	esentative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
Product-Env-Ste	wards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Reque	ster Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	e Versio	n I	Manufacturing Site		Weight*	UOM	Unit Type	
		FAN3229CMX Dual 2A Low-		Dual 2A Low-Side	-Side Drive		2024-05-18	TH2			83.484	mg	Each		
<b>Ianufacturin</b>	g Proccess Informat	ion													
Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Temperat		Temperatu	re Max Time at Peal	k Tempera	ture Numb	er of Reflow Cyc	eles		
Matte Tin (Sn) - annealed			CU Alloy 1				260   C   30		seco	nds 3					
omments															
vel 1 - maximun	n time at peak temperatu	re during sol	dering is 10-3	30 seconds											
or more informa	ntion regarding material o	composition	please refer t	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provi											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.16	mg	Supplier	Silicon (Si)	7440-21-3		2.16	mg
Die Attach	1.144	mg		Epoxy resin	proprietary data		0.1487	mg
			Supplier	Silver (Ag)	7440-22-4		0.4004	mg
			Supplier	Acrylic resins	Proprietary Data		0.1945	mg
			Supplier	Aluminum (Al)	7429-90-5		0.4004	mg
Lead Frame	31.136	mg	Supplier	Silver (Ag)	7440-22-4		1.5568	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0374	mg
			Supplier	Iron (Fe)	7439-89-6		0.7473	mg
			Supplier	Copper (Cu)	7440-50-8		28.7697	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0249	mg
Mold Compound-Black	45.29	mg	Supplier	4,4'-Bis(2,3-epoxypropoxy)-3,3',5,5'-tetramethylbiphenyl	85954-11-6		2.0381	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2264	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		41.6668	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.3587	mg
Plating	3.44	mg	Supplier	Tin (Sn)	7440-31-5		3.44	mg
Wire Bond	0.314	mg	Supplier	Palladium (Pd)	7440-05-3		0.0097	mg
			Supplier	Gold (Au)	7440-57-5		0.0011	mg
			Supplier	Copper (Cu)	7440-50-8		0.3032	mg